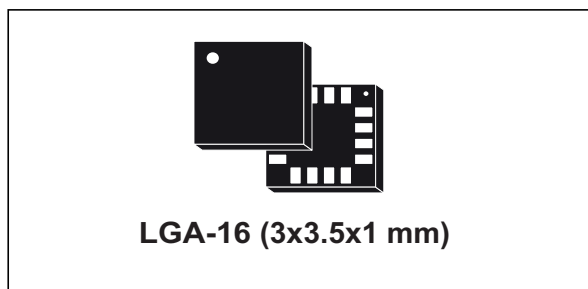


## MEMS motion sensor: three-axis digital output gyroscope for optical image stabilization

Datasheet - production data



### Features

- $\pm 65$  dps /  $\pm 130$  dps full-scale range
- SPI digital interface
- Embedded temperature sensor
- Integrated low- and high-pass filters with user-selectable bandwidth
- Wide supply voltage range: 2.4 V to 3.6 V
- Low-voltage compatible IOs (1.8 V)
- Power-down and sleep modes for smart power saving
- ECOPACK<sup>®</sup>, RoHS and “Green” compliant

### Applications

- Optical image stabilization

### Description

The L3G3IS is a three-axis MEMS gyroscope for optical image stabilization applications.

It includes a sensing element and an IC interface capable of providing the measured angular rate to the external world through an SPI digital interface.

The unique sensing element is manufactured using a dedicated micromachining process developed by STMicroelectronics to produce inertial sensors and actuators on silicon wafers.

The IC interface is manufactured using a CMOS process that allows a high level of integration to design a dedicated circuit which is trimmed to better match the sensing element characteristics.

The L3G3IS is available in a plastic land grid array (LGA) package and can operate over a temperature range of -40 °C to +85 °C.

**Table 1. Device summary**

Order code	Temperature range (°C)	Package	Packing
L3G3IS	-40 to +85	LGA-16 (3x3.5x1)	Tray
L3G3ISTR	-40 to +85	LGA-16 (3x3.5x1)	Tape and reel

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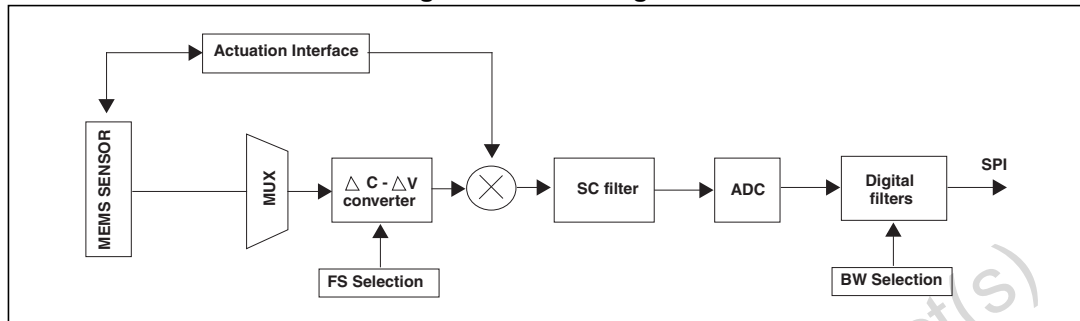
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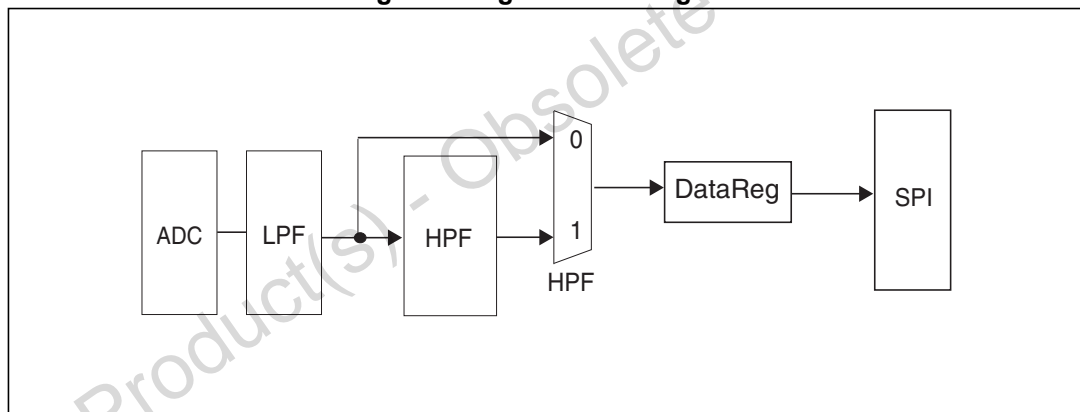
# 1 Block diagrams and pin description

Figure 1. Block diagram



## 1.1 Digital block diagram

Figure 2. Digital block diagram



## 1.2 Pin description

Figure 3. Pin connections

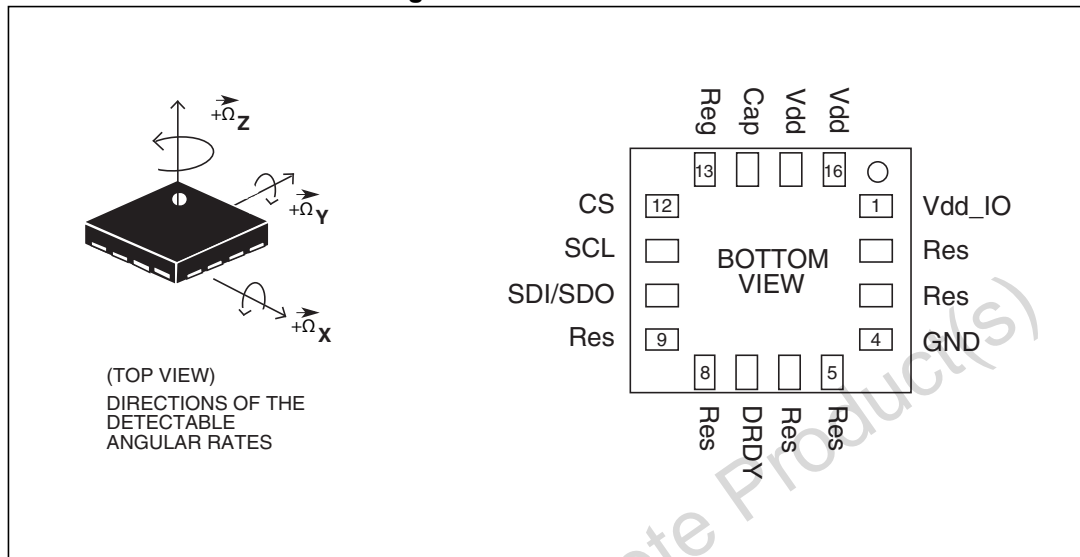


Table 2. Pin description

Pin#	Name	Function
1	Vdd_IO	Power supply for I/O pins
2	Res	Connect to GND
3	Res	Connect to GND
4	GND	0 V power supply
5	Res	Leave unconnected
6	Res	Connect to GND
7	DRDY	Data ready signal (open-drain pad)
8	Res	Leave unconnected
9	Res	Leave unconnected
10	SDI/SDO	Data-in, data-out line
11	SCL	Clock line for SPI interface
12	CS	SPI chip-select line
13	Reg	Capacitance connection pin for internal regulator
14	Cap	Capacitance connection pin for internal charge pump
15	Vdd	Power supply
16	Vdd	Power supply

## 2 Terminology & functionality

### 2.1 Sensitivity

An angular rate gyroscope is a device that produces a positive-going digital output for counterclockwise rotation around the sensitive axis considered. Sensitivity describes the gain of the sensor and can be determined by applying a defined angular velocity to it. This value changes very little over temperature and time.

### 2.2 Zero-rate level

The zero-rate level describes the actual output signal if there is no angular rate present. The zero-rate level of highly accurate MEMS sensors is, to some extent, a result of stress to the sensor and therefore the zero-rate level can slightly change after mounting the sensor on a printed circuit board or after exposing it to extensive mechanical stress. This value changes very little over temperature and time.

### 2.3 Synchronous reading

On the L3G3IS the angular rate data can be retrieved using a synchronous read. This functionality is recommended to improve the sensor performance.

To perform a synchronous read when using the SPI interface, the REG\_EN bit in [CTRL\\_REG1 \(0Bh\)](#) has to be set to '1'. Then the DRDY\_EN bit in [CTRL\\_REG4 \(15h\)](#) has to be set to '1' in order to enable the data ready interrupt on the DRDY pin (refer to [Figure 5](#)).

To properly perform a synchronous read, the angular rate data have to be read every time the DRDY pin goes low.

### 2.4 Temperature sensor

To retrieve the temperature data, the gyroscope has to be in sleep mode (PW<1:0> bit in [CTRL\\_REG1 \(0Bh\)](#) set to '10'), the REG\_EN bit in [CTRL\\_REG1 \(0Bh\)](#) has to be set to '1' and the temperature sensor can be enabled by setting the TEMP\_EN bit to '1' in [CTRL\\_TEMP \(20h\)](#).

The temperature data can be retrieved from the [OUT\\_TEMP \(26h\)](#) register, as two's complement data in 8-bit format left-justified. The output of the temperature sensor is 0 at 25 °C.

Once the temperature data have been acquired, the temperature sensor has to be turned off to restart the acquisition of the angular rate data. The TEMP\_EN bit in [CTRL\\_TEMP \(20h\)](#) has to be set to '0' and the gyroscope operative mode has to be changed to normal mode (PW<1:0> bit in [CTRL\\_REG1 \(0Bh\)](#) set to '11').



### 3 Mechanical and electrical characteristics

#### 3.1 Mechanical characteristics

V<sub>dd</sub> = 3.3 V and T = 25 °C unless otherwise noted<sup>(a)</sup>.

**Table 3. Mechanical characteristics**

Symbol	Parameter	Test condition	Min.	Typ. <sup>(1)</sup>	Max.	Unit
FS	Measurement range		±65			dps
			±130			
So	Sensitivity	FS = ±65 dps		225		LSb/dps
		FS = ±130 dps		112.5		
SoDr	Sensitivity change vs. temperature	From -40 °C to +85 °C		±3		%
DVoff	Digital zero-rate level			±5		dps
OffDr	Zero-rate level change vs. temperature	From -40 °C to +85 °C		±9		dps
NL	Non-linearity <sup>(2)</sup>	Best-fit straight line		±0.1		% FS
Rn	Rate noise density <sup>(2)</sup>	0 - 20 Hz bandwidth		0.006		dps/(√Hz)
BW	Internal bandwidth	LPF set to '1'		370		Hz
PhDI	Phase delay	At 20 Hz (370 Hz BW selected)		4.5		deg
ODR	Digital output data rate			9.5		kHz
Top	Operating temperature range		-40		+85	°C

1. Typical specifications are not guaranteed.

2. Guaranteed by design.

a. The product is factory calibrated at 3.3 V. The operational power supply range is specified in [Table 4](#).

### 3.2 Electrical characteristics

@ Vdd = 3.3 V, T = 25 °C unless otherwise noted<sup>(b)</sup>.

**Table 4. Electrical characteristics**

Symbol	Parameter	Test condition	Min.	Typ. <sup>(1)</sup>	Max.	Unit
Vdd	Supply voltage		2.42	3.3	3.6	V
Vdd_IO	I/O pins supply voltage <sup>(2)</sup>		1.71		Vdd+0.1	V
Idd	Supply current in normal mode			6.4		mA
IddSL	Supply current in sleep mode <sup>(3)</sup>			2.5		mA
IddPdn	Supply current in power-down mode			20		µA
VIH	Digital high-level input voltage		0.8*Vdd_IO			V
VIL	Digital low-level input voltage				0.2*Vdd_IO	V
Top	Operating temperature range		-40		+85	°C

1. Typical specifications are not guaranteed.

2. It is possible to remove Vdd maintaining Vdd\_IO without blocking the communication busses, in this condition the measurement chain is powered off.

3. Sleep mode introduces a faster turn-on time relative to power-down mode.

b. The product is factory calibrated at 3.3 V.

### 3.3 Temperature sensor characteristics

@ AVdd = 3.3 V, T = 25 °C unless otherwise noted<sup>(c)</sup>.

**Table 5. Electrical characteristics**

Symbol	Parameter	Test condition	Min.	Typ. <sup>(1)</sup>	Max.	Unit
TSDr	Temperature sensor output change vs. temperature			1		°C/digit
TODR	Temperature refresh rate			1		Hz
TACC	Temperature absolute accuracy <sup>(2)</sup>			±4		°C
Top	Operating temperature range		-40		+85	°C

1. Typical specifications are not guaranteed.
2. The output of the temperature sensor is 0 at 25 °C. Refer to [Section 2.4: Temperature sensor](#) on how to enable and read the temperature sensor output data.

c. The product is factory calibrated at 3.3 V.

### 3.4 SPI - serial peripheral interface

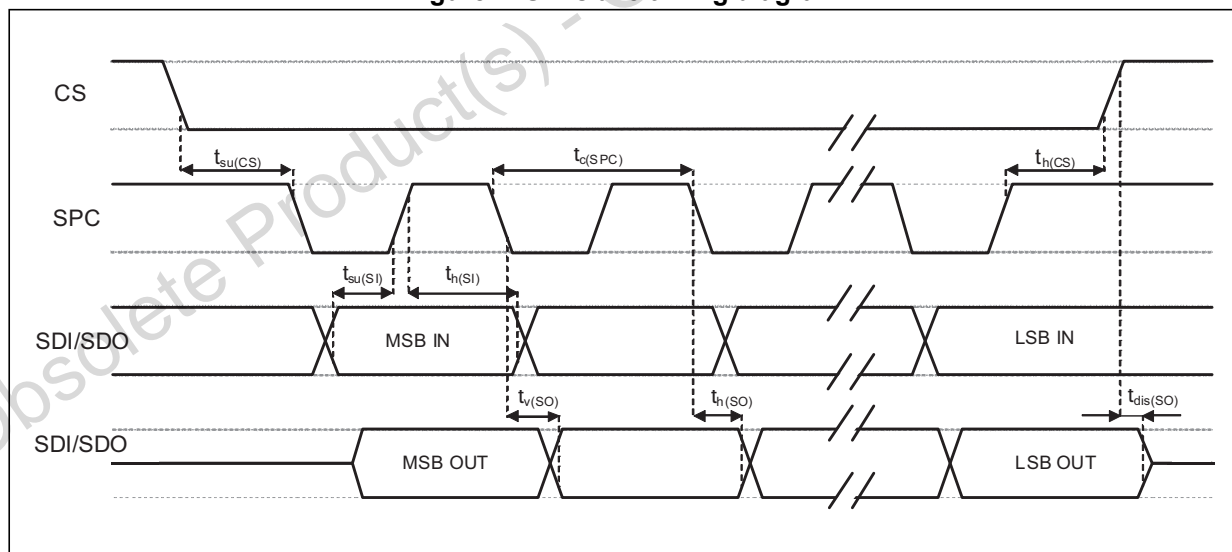
Subject to general operating conditions for Vdd and Top.

**Table 6. SPI slave timing values**

Symbol	Parameter	Value <sup>(1)</sup>		Unit
		Min	Max	
$t_{c(SPC)}$	SPI clock cycle	100		ns
$f_{c(SPC)}$	SPI clock frequency		10	MHz
$t_{su(CS)}$	CS setup time	5		ns
$t_{h(CS)}$	CS hold time	8		
$t_{su(SI)}$	SDI input setup time	5		
$t_{h(SI)}$	SDI input hold time	15		
$t_{v(SO)}$	SDO valid output time		50	
$t_{h(SO)}$	SDO output hold time	6		
$t_{dis(SO)}$	SDO output disable time		50	

1. Values are guaranteed at 10 MHz clock frequency for SPI, based on characterization results, not tested in production.

**Figure 4. SPI slave timing diagram**



**Note:** Measurement points are done at  $0.2 \cdot V_{dd\_IO}$  and  $0.8 \cdot V_{dd\_IO}$ , for both input and output ports.

### 3.5 Absolute maximum ratings

Stresses above those listed as “absolute maximum ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**Table 7. Absolute maximum ratings**

Symbol	Ratings	Maximum value	Unit
AVdd	Supply voltage	-0.3 to 4.8	V
HAVdd	Supply voltage	-0.3 to 4.8	V
Vdd_IO	Vdd IO	-0.3 to Vdd	V
Vin	Input voltage on: (CS, SDI/SDO, SCL)	-0.3 to Vdd_IO +0.1	V
T <sub>STG</sub>	Storage temperature range	-40 to +125	°C
Sg	Acceleration <i>g</i> for 0.1 ms	10,000	<i>g</i>
ESD	Electrostatic discharge protection	2 (HBM)	kV

**Note:** Supply voltage on any pin should never exceed 4.8 V.



This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.



This device is sensitive to electrostatic discharge (ESD), improper handling can cause permanent damage to the part.

# 4 Application hints

Figure 5. L3G3IS electrical connections and external component values

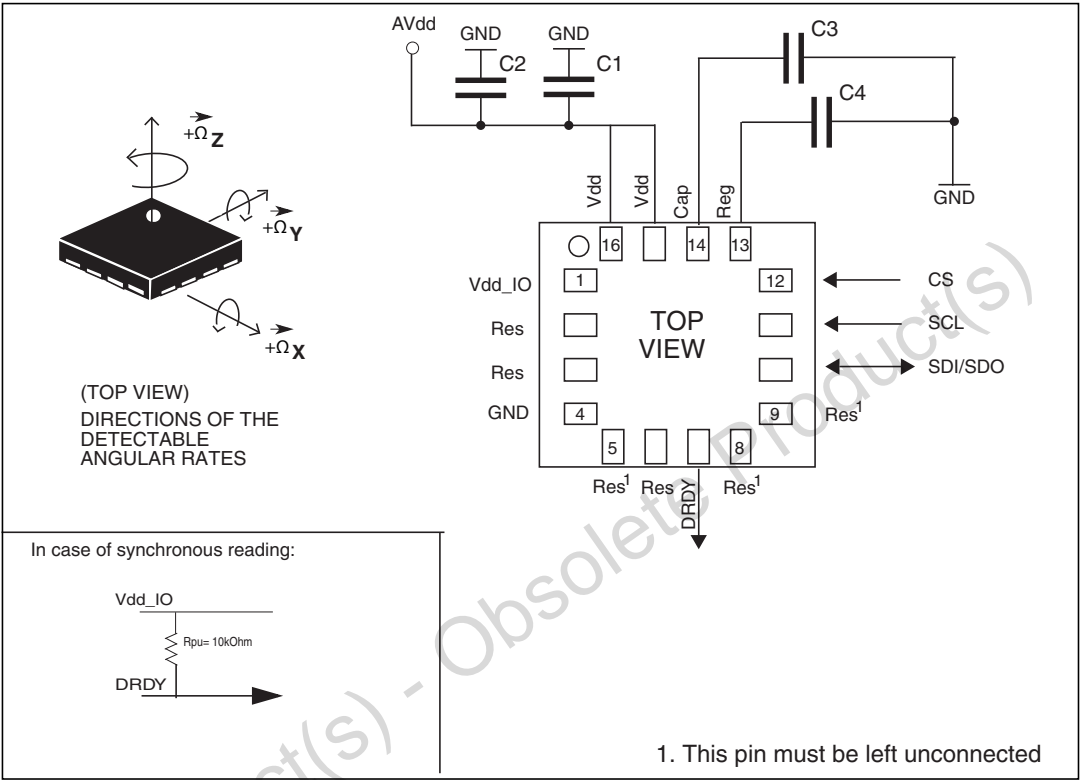


Table 8. External components

Type description	Value	Purpose
C1	1 µF	Decoupling
C2	100 pF	Decoupling
C3 <sup>(1)</sup>	10 nF (16 V class)	Charge pump
C4	220 nF (5 V class)	Internal regulator

1. This value must guarantee a minimum of 1 nF value under 12 V bias condition.

Power supply decoupling capacitors (100 pF + 1 µF) should be placed as near as possible to the device (common design practice). A pull-up resistor must be added to the DRDY line (open-drain pad).

## 5 Digital interfaces

The registers embedded inside the L3G3IS may be accessed through the SPI serial interfaces.

**Table 9. Serial interface pin description**

Pin name	Pin description
CS	Chip-select line
SCL	SPI serial port clock
SDI/SDO	SPI serial data input/output

### 5.1 SPI bus interface

The SPI is a bus slave. The SPI allows to write and read the registers of the device.

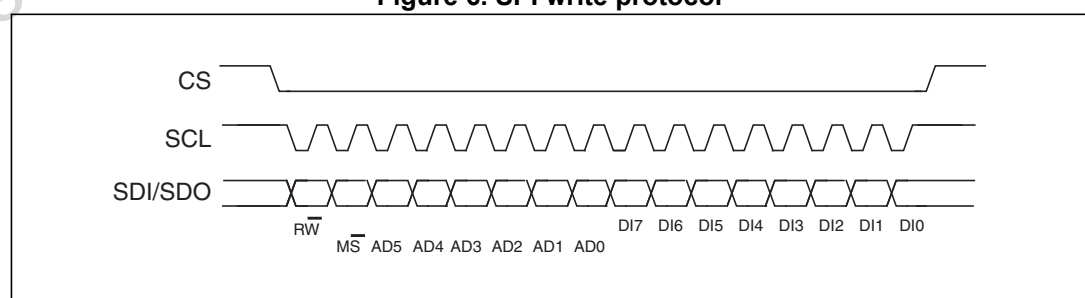
The serial interface interacts with the outside world with 3 wires: **CS**, **SCL**, **SDI/SDO**.

**CS** is the serial port enable and it is controlled by the SPI master. It goes low at the start of the transmission and goes back high at the end. **SCL** is the serial port clock and it is controlled by the SPI master. It is stopped high when **CS** is high (no transmission). **SDI/SDO** is the serial port data input and output. This line is driven at the falling edge of **SCL** and should be captured at the rising edge of **SCL**.

Both the read register and write register commands are completed in 16 clock pulses or in multiples of 8 in case of multiple read/write bytes. Bit duration is the time between two falling edges of **SCL**. The first bit (bit 0) starts at the first falling edge of **SCL** after the falling edge of **CS** while the last bit (bit 15, bit 23, ...) starts at the last falling edge of **SCL** just before the rising edge of **CS**.

#### 5.1.1 SPI write

**Figure 6. SPI write protocol**



The SPI write command is performed with 16 clock pulses. A multiple byte write command is performed by adding blocks of 8 clock pulses to the previous one.

**bit 0:** WRITE bit. The value is 0.

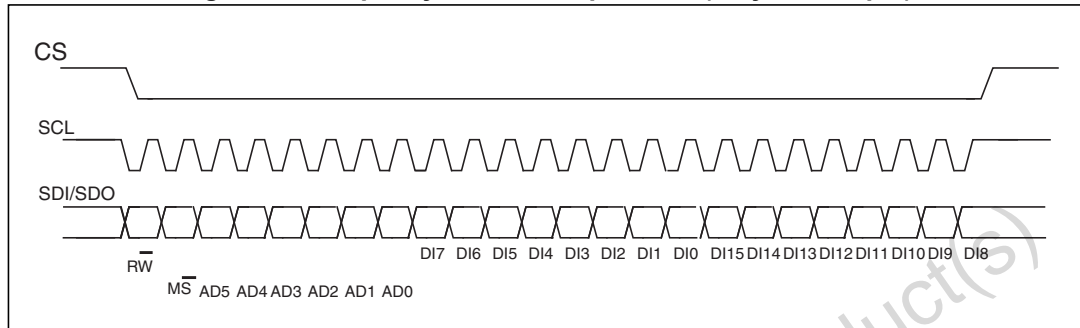
**bit 1:**  $\overline{MS}$  bit. When 0, does not increment the address; when 1, increments the address in multiple writes.

**bit 2 -7:** address AD(5:0). This is the address field of the indexed register.

**bit 8-15:** data DI(7:0) (write mode). This is the data that will be written inside the device (MSb first).

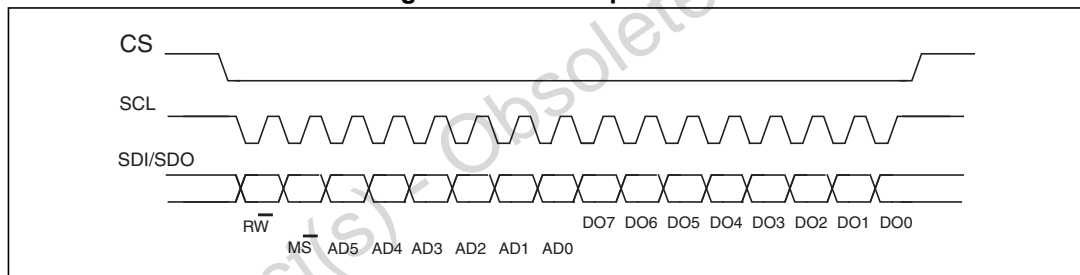
**bit 16-...** : data DI(...-8). Further data in multiple byte writes.

**Figure 7. Multiple byte SPI write protocol (2-byte example)**



### 5.1.2 SPI read

**Figure 8. SPI read protocol**



The SPI Read command is performed with 16 clock pulses:

**bit 0:** READ bit. The value is 1.

**bit 1:**  $\overline{MS}$  bit. When 0, does not increment the address; when 1, increments the address in multiple reads.

**bit 2-7:** address AD(5:0). This is the address field of the indexed register.

**bit 8-15:** data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

A multiple read command is also available.



## 6 Output register mapping

The table given below provides a listing of the 8-bit registers embedded in the device and the related addresses.

**Table 10. Register address map**

Name	Type	Register address [Hex]	Default [Hex]	Comment
Reserved	--	00-02	--	Reserved
OUT_X_L	r	03	output	
OUT_X_H	r	04	output	
OUT_Y_L	r	05	output	
OUT_Y_H	r	06	output	
OUT_Z_L	r	07	output	
OUT_Z_H	r	08	output	
STATUS_REG	r	09	output	
Reserved	--	0A	--	Reserved
CTRL_REG1	rw	0B	01	
CTRL_REG2	rw	0C	00	
CTRL_REG3	rw	0D	00	
ORIENT_CONFIG	rw	10	00	
Reserved	--	11-14	--	Reserved
CTRL_REG4	rw	15	00	
Reserved	--	16-1E	--	Reserved
CTRL_REG5	rw	1F	00	
CTRL_TEMP	rw	20	04	
Reserved	--	21-25	--	Reserved
OUT_TEMP	r	26	output	

Registers marked as Reserved must not be changed. Writing to those registers may cause permanent damage to the device.

To guarantee proper behavior of the device, all register addresses not listed in the above table must not be accessed and the content stored in those registers must not be changed.

The content of the registers that are loaded at boot should not be changed. They contain the factory calibration values. Their content is automatically restored when the device is powered up.

## 7 Register description

The device contains a set of registers which are used to control its behavior and to retrieve angular rate data. The register address, consisting of 7 bits, is used to identify them and to write the data through the serial interface.

### 7.1 OUT\_X\_L (03h), OUT\_X\_H (04h)

X-axis angular rate data. The value is expressed as two's complement.

### 7.2 OUT\_Y\_L (05h), OUT\_Y\_H (06h)

Y-axis angular rate data. The value is expressed as two's complement.

### 7.3 OUT\_Z\_L (07h), OUT\_Z\_H (08h)

Z-axis angular rate data. The value is expressed as two's complement.

### 7.4 STATUS\_REG (09h)

Table 11. STATUS\_REG register

ZYXOR	XOR	YOR	ZOR	ZYXDA	XDA	YDA	ZDA
-------	-----	-----	-----	-------	-----	-----	-----

Table 12. STATUS\_REG description

ZYXOR	X, Y, Z -axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data has overwritten the previous data)
XOR	X-axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the X-axis has overwritten the previous data)
YOR	Y-axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the Y-axis has overwritten the previous data)
ZOR	Z-axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the Z-axis has overwritten the previous data)
ZYXDA	X, Y, Z -axis new data available. Default value: 0 (0: a new set of data is not yet available; 1: a new set of data is available)
XDA	X-axis new data available. Default value: 0 (0: new data for the X-axis is not yet available; 1: new data for the X-axis is available)
YDA	Y-axis new data available. Default value: 0 (0: new data for the Y-axis is not yet available; 1: new data for the Y-axis is available)
ZDA	Z-axis new data available. Default value: 0 (0: new data for the Z-axis is not yet available; 1: new data for the Z-axis is available)

## 7.5 CTRL\_REG1 (0Bh)

**Table 13. CTRL\_REG1 register**

0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	BDU	REG_EN	PW1	PW0
------------------	------------------	------------------	------------------	-----	--------	-----	-----

1. These bits must be set to '0' for proper operation of the device.

**Table 14. CTRL\_REG1 description**

BDU	Block data update. Default value: 0. (0: output registers not updated until MSB and LSB have been read; 1: output registers updated continuously)
REG_EN	Enables writing to <a href="#">CTRL_REG4 (15h)</a> , <a href="#">CTRL_REG5 (1Fh)</a> and <a href="#">CTRL_TEMP (20h)</a> . Default value: 0. (1: enable write values in <a href="#">CTRL_REG4 (15h)</a> , <a href="#">CTRL_REG5 (1Fh)</a> and <a href="#">CTRL_TEMP (20h)</a> )
PW[1:0]	Operating mode selection. Default: 01. Refer to <a href="#">Table 15: Operating mode selection</a> .

**Table 15. Operating mode selection**

PW1	PW0	Operating mode selection
0	0	Power-down
0	1	Power-down
1	0	Sleep mode
1	1	Normal mode

## 7.6 CTRL\_REG2 (0Ch)

**Table 16. CTRL\_REG2 register**

0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	HPFreset0	HPFreset1	HPFreset2	SWreset	HPF
------------------	------------------	------------------	-----------	-----------	-----------	---------	-----

1. These bits must be set to '0' for proper operation of the device.

**Table 17. CTRL\_REG2 description**

HPFreset0	High-pass filter reset. Default: 0. To reset the HPF, HPFreset2 or HPFreset1 or HPFreset0 has to be set to 1. (1: HPF reset on X-axis, Y-axis and Z-axis)
HPFreset1	High-pass filter reset. Default: 0. To reset the HPF, HPFreset2 or HPFreset1 or HPFreset0 has to be set to 1. (1: HPF reset on X-axis, Y-axis and Z-axis)
HPFreset2	High-pass filter reset. Default: 0. To reset the HPF, HPFreset2 or HPFreset1 or HPFreset0 has to be set to 1. (1: HPF reset on X-axis, Y-axis and Z-axis)
SWreset	Software reset. Default: 0. (1: all control and output register values are restored to default values).
HPF	High-pass filter enable. Default: 0. (0: high-pass filter is disabled; 1: high-pass filter is enabled)

## 7.7 CTRL\_REG3 (0Dh)

**Table 18. CTRL\_REG3 register**

0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	LPF
------------------	------------------	------------------	------------------	------------------	------------------	------------------	-----

1. These bits must be set to '0' for proper operation of the device

**Table 19. CTRL\_REG3 description**

LPF	Low-pass filter cutoff frequency selection. Default value 0. (0: 120Hz; 1: 370Hz). If LPF2 in <a href="#">CTRL_REG5 (1Fh)</a> is set to '1', the cutoff frequency is set to 240 Hz, independently of the value of LPF.
-----	------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------

**Table 20. Low-pass filter cutoff frequency**

LPF	LPF2 ( <a href="#">CTRL_REG5 (1Fh)</a> )	Low-pass filter cutoff frequency selection
0	0	120 Hz
1	0	370 Hz
0	1	240 Hz
1	1	240 Hz

## 7.8 ORIENT\_CONFIG (10h)

**Table 21. ORIENT\_CONFIG register**

0 <sup>(1)</sup>	0 <sup>(1)</sup>	Sign_x	Sign_y	Sign_z	Orient_2	Orient_1	Orient_0
------------------	------------------	--------	--------	--------	----------	----------	----------

1. These bits must be set to '0' for proper operation of the device

**Table 22. ORIENT\_CONFIG description**

Sign_x	X-axis angular rate sign. Default 0. (0: sign unvaried; 1: sign inverted)
Sign_y	Y-axis angular rate sign. Default 0. (0: sign unvaried; 1: sign inverted)
Sign_Z	Z-axis angular rate sign. Default 0. (0: sign unvaried; 1: sign inverted)
Orient[2:0]	Directional orientation selection. Default 000. Refer to <a href="#">Table 23: Directional orientation selection</a>

**Table 23. Directional orientation selection**

Orient_2	Orient_1	Orient_0	Directional orientation selection
0	0	0	x-axis - y-axis - z-axis
0	0	1	x-axis - z-axis - y-axis
0	1	0	y-axis - x-axis - z-axis
0	1	1	z-axis - x-axis - y-axis
1	0	0	y-axis - z-axis - x-axis
1	0	1	z-axis - y-axis - x-axis

## 7.9 CTRL\_REG4 (15h)

To enable writing to the [CTRL\\_REG4 \(15h\)](#) register, the REG\_EN bit in [CTRL\\_REG1 \(0Bh\)](#) has to be set to '1'.

**Table 24. CTRL\_REG4 register**

0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	DRDY_EN
------------------	------------------	------------------	------------------	------------------	------------------	------------------	---------

1. These bits must be set to '0' for proper operation of the device.

**Table 25. CTRL\_REG4 description**

DRDY_EN	Data ready enable on DRDY pin. Default 0. (1: DRDY on pin). Refer to <a href="#">Section 2.3: Synchronous reading</a> .
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## 7.10 CTRL\_REG5 (1Fh)

To enable writing to the [CTRL\\_REG5 \(1Fh\)](#) register, the REG\_EN bit in [CTRL\\_REG1 \(0Bh\)](#) has to be set to '1'.

**Table 26. CTRL\_REG5 register**

--	--	--	--	FS	LPF2	HPF_BW1	HPF_BW0
----	----	----	----	----	------	---------	---------

**Table 27. CTRL\_REG5 description**

FS	Full-scale selection. Default value: 0 (0: $\pm 65$ dps; 1: $\pm 130$ dps)
LPF2	Enable low-pass filter 240 Hz. Default 0. If LPF2 is enabled, the cutoff frequency is set to 240 Hz, independently of the value of the LPF bit in <a href="#">CTRL_REG3 (0Dh)</a> . Refer to <a href="#">Table 20: Low-pass filter cutoff frequency</a> .
HPF_BW[1:0]	Digital high-pass filter cutoff frequency selection. Default value 00. Refer to <a href="#">Table 28: High-pass filter cutoff frequency selection</a>

Table 28. High-pass filter cutoff frequency selection

HPF_BW1	HPF_BW0	HP cutoff frequency selection
0	0	0.02 Hz
0	1	0.08 Hz
1	0	4.85 Hz
1	1	39.6 Hz

## 7.11 CTRL\_TEMP (20h)

To enable writing to the [CTRL\\_TEMP \(20h\)](#) register, the REG\_EN bit in [CTRL\\_REG1 \(0Bh\)](#) has to be set to '1'.

Table 29. CTRL\_TEMP register

0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>	TEMP_EN	1 <sup>(2)</sup>	0 <sup>(1)</sup>	0 <sup>(1)</sup>
------------------	------------------	------------------	------------------	---------	------------------	------------------	------------------

1. These bits must be set to '0' for proper operation of the device.
2. This bit must be left at '1' for proper operation of the device.

Table 30. CTRL\_TEMP description

TEMP_EN	Temperature sensor enable. Default 0 (0: temperature sensor is disabled; 1: temperature sensor is enabled). Refer to: <a href="#">Section 2.4: Temperature sensor</a> on how to enable and read the temperature sensor output data.
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## 7.12 OUT\_TEMP (26h)

Table 31. OUT\_TEMP register

Temp7	Temp6	Temp5	Temp4	Temp3	Temp2	Temp1	Temp0
-------	-------	-------	-------	-------	-------	-------	-------

Table 32. OUT\_TEMP description

Temp7-Temp0	Temperature data. The value is expressed as two's complement left-justified. The output of the temperature sensor is 0 at 25 °C. Refer to: <a href="#">Section 2.4: Temperature sensor</a> on how to enable and read the temperature sensor output data.
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## 8 Soldering information

The LGA package is compliant with the ECOPACK<sup>®</sup>, RoHS and “Green” standard. It is qualified for soldering heat resistance according to JEDEC J-STD-020.

Leave “Pin 1 Indicator” unconnected during soldering.

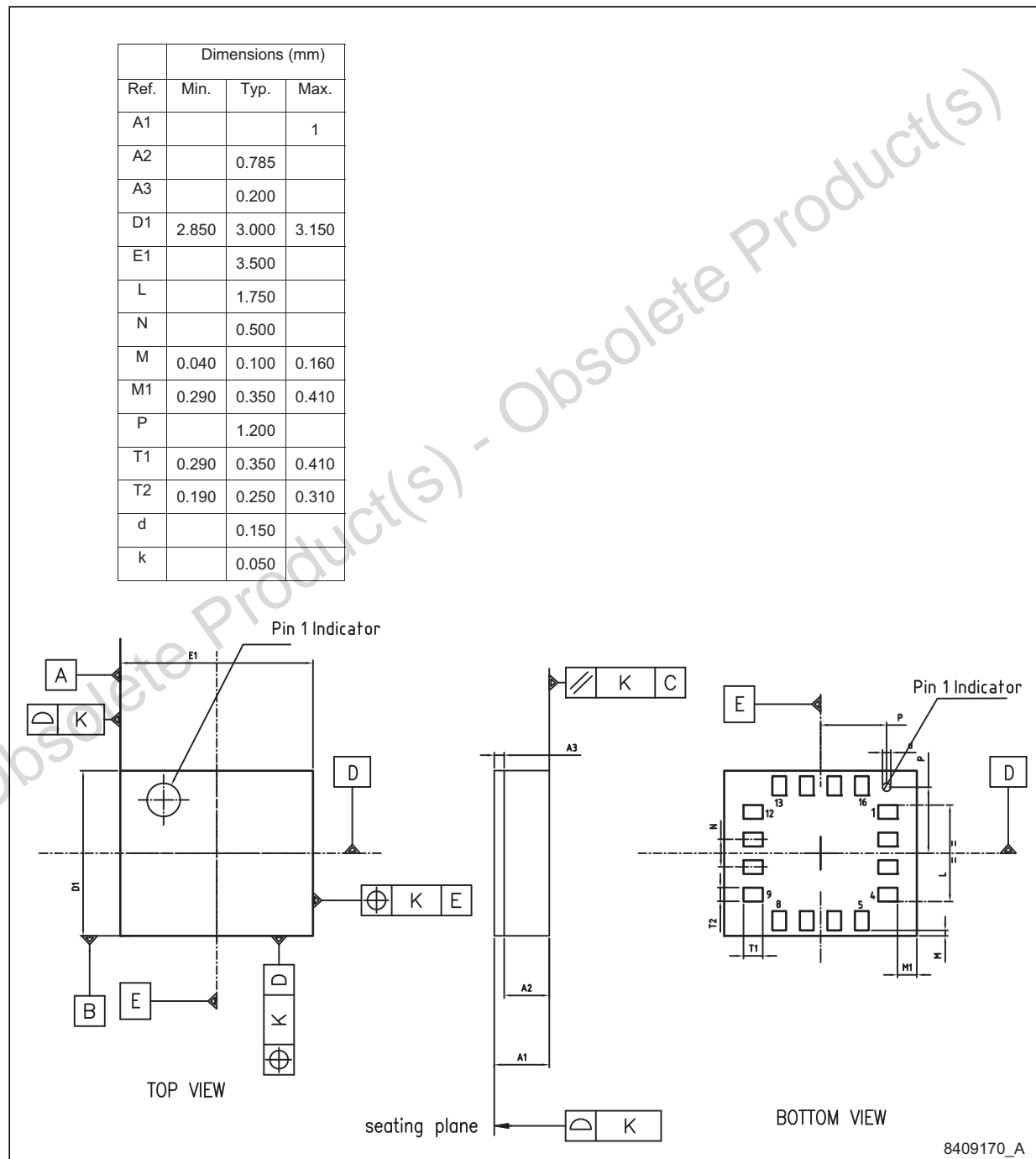
Land pattern and soldering recommendations are available at [www.st.com/mems](http://www.st.com/mems).

Obsolete Product(s) - Obsolete Product(s)

## 9 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

**Figure 9. LGA-16: mechanical data and package dimensions**





## 10 Revision history

**Table 33. Document revision history**

Date	Revision	Changes
16-Jul-2013	1	Initial release
28-Aug-2013	2	Updated <i>Figure 3: Pin connections</i> and <i>Figure 5: L3G3IS electrical connections and external component values</i> Moved <i>Figure 2: Digital block diagram</i>
05-Dec-2013	3	Document status promoted from preliminary data to production data; updated <i>Table 16: CTRL_REG2 register</i> and <i>Table 17: CTRL_REG2 description</i>

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